

S393

Thermal Conductive Pad

LiPOLY S393 is the thermal conductive pad for gap filling, which can fit closely. The thermal conductivity is 2.2W/m*K. The material is with great self-adhesive that can fit closely with not flatness heat sink to increase the contacting area. The low stress damped vibration, and shock absorption, which is an outstanding electric insulating material. LiPOLY's ability of research and development is providing our best thermal solution to customers, which can satisfy customer special requirement on advanced product.

The product is qualified for UL.

Features-

- Thermal conductivity:2.2W/m*K
- · Eazy to assemble
- · High reliability
- · Shock and vibrating absorber

Typical Applications-

- Between a component and heat sink
- · Flat-panel displays
- · LED
- · HDDs,DVDs
- · Heat pipe assemblies
- · Memory modules
- · Power supplies

Specifications-

- · Sheet form
- · Die-cut parts

sa	393	TEST METHOD	UNIT
Light	green	Visual	-
	2	-	-
0.3~15		ASTM D374	mm
2.4		ASTM D792	g/cm ³
15		ASTM D2240	Shore A
-60~200		-	°C
80		ASTM D412	psi
1.0mm	2.0mm		
4	9	-	%
7	22	-	%
12	27	-	%
16	30	-	%
20	33	-	%
10		ASTM D149	KV/mm
>1	010	ASTM D257	Ohm
>1011		ASTM D257	Ohm-m
2.2		ASTM D5470	W/m*K
1.29		ASTM D5470	°C-in²/W
1.	24	ASTM D2470	°C-in²/W
1.	16	ASTM D5470	°C-in²/W
V	'-0	UL94	-
	Light 0.3 2 1 -60- 8 1.0mm 4 7 12 16 20 1 >1 >1 1.1	2.4 15 -60~200 80 1.0mm	Light green Visual 2 - 0.3~15 ASTM D374 2.4 ASTM D792 15 ASTM D2240 -60~200 - 80 ASTM D412 1.0mm 2.0mm 4 9 7 22 12 27 16 30 20 33 - ASTM D149 >10 ¹⁰ ASTM D257 >10 ¹¹ ASTM D257 2.2 ASTM D5470 1.29 ASTM D5470 1.24 ASTM D2470 1.16 ASTM D5470

^{*}These data are provided for reference only. Engineers are reminded to test the material in varied application.